

# ABA3115 870 MHz Balanced Low Noise Linear Amplifier DATA SHEET - Rev 2.0

### **FEATURES**

- 15 dB Gain
- +5 V Nominal Supply Voltage
- High Linearity
- Low Noise Figure: 2.7 dB (typ.)
- Characterized at +25 dBmV output power
- Wide Band operation to 870 MHz
- · Shutdown Mode
- -40 to +85 °C
- RoHS-Compliant Package

## **APPLICATIONS**

- Driver Amplifier
- CATV Distribution / Drop Amplifiers
- Set Top Boxes
- Home Gateway

## PRODUCT DESCRIPTION

The ABA3115 is a monolithic IC intended for use in applications requiring high linearity, such as Cellular Telephone Base Station Driver Amplifiers, CATV Fiber Receiver and Distribution Amplifiers, CATV Drop Amplifiers, CATV Set Top Boxes and Home Gateways. Offered in a modified 16 lead surface mount SOIC



package that is RoHS-Compliant, it is well suited for use in amplifiers where small size, reduced component count, and high reliability are important. The ABA3115 incorporates a shutdown feature under logic control whereby power consumption is reduced to 15 mW with a +5 V supply.

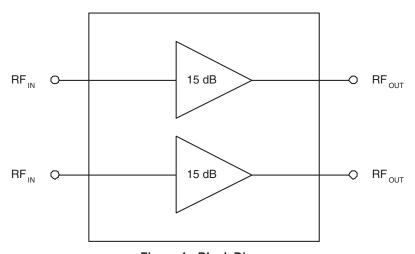


Figure 1: Block Diagram

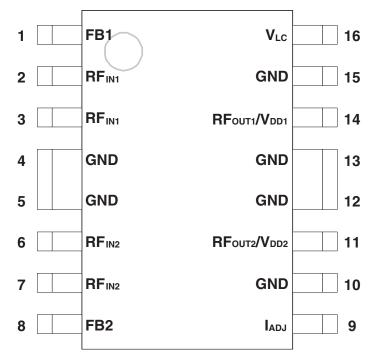


Figure 2: Pin Out

Table 1: Pin Description

PIN	NAME	DESCRIPTION	PIN	NAME	DESCRIPTION			
1	FB1	Feedback for Amplifier A1	9	<b>l</b> adj	Current Adjust			
2	RF <sub>IN1</sub>	RF Input of Amplifier A1	10	GND	Ground			
3	RF <sub>IN1</sub>	RFInput of Amplifier A1	11	RFOUT2/VDD2	RF output and VDD of Amplifier A2			
4	GND	Ground	12	GND	Ground			
5	GND	Ground	13	GND	Ground			
6	RF <sub>IN2</sub>	RF Input of Amplifier A2	14	RFout1/VDD1	RF output and VDD of Amplifier A1			
7	RF <sub>IN2</sub>	RF Input of Amplifier A2	15	GND	Ground			
8	FB2	Feedback for Amplifier A2	16	VLC	Shutdown Logic Control			

# **ELECTRICAL CHARACTERISTICS**

**Table 2: Absolute Minimum and Maximum Ratings** 

PARAMETER	MIN	MAX	UNIT
Analog Supply (pins 11, 14)	0	+12	VDC
Shutdown Logic Control (pin 16)	0	+6	VDC
RF Power at Inputs (pins 2, 3, 6, 7)	-	+10	dBm
Storage Temperature	-65	+150	°C
Soldering Temperature	-	260	°C
Soldering Time	-	5	sec

Stresses in excess of the absolute ratings may cause permanent damage. Functional operation is not implied under these conditions. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Notes:

**Table 3: Operating Ranges** 

PARAMETER	MIN	TYP	MAX	UNIT
RF Input / Output Frequency	50	-	870	MHz
Analog Supply: VDD (pins 11, 14)	+4.5	+5	+9	VDC
Shutdown Logic Control: VLc (pin 16)	0	-	+6	V
Case Temperature: TA	-40	-	+85	°C

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

<sup>1.</sup> Pins 1, 2, 3, 6, 7 and 8 should be AC-coupled. No external DC bias should be applied.

<sup>2.</sup> Pin 9 should be AC-grounded. No external DC bias should be applied.

Table 4: Electrical Specifications

(TA = +25 °C, V<sub>DD</sub> = + 5 VDC, V<sub>LC</sub> = +5 V, Test System =  $75\Omega$ )

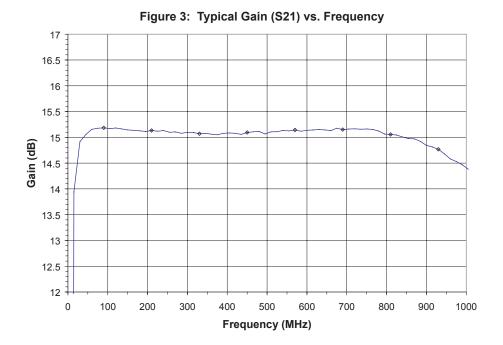
PARAMETER MIN TYP MAX UNIT COMMENTS							
PARAMETER	IVIIIV	IIP	IVIAA	UNII	COMMENTS		
Gain	14	15	17	dB			
Noise Figure	1 1 1	2.5 2.7 3.2	3.0 3.5 4.0	dB	50 - 350 MHz 350 - 550 MHz 550 - 860 MHz		
Input / Output Return Loss	10	18	-	dB			
CSO (1)	-	-72	-70	dBc			
CTB (1)	-	-75	-73	dBc			
2nd Order Output Intercept Point (OIP2) (2)	1	+60	ı	dBm			
3rd Order Output Intercept Point (OIP3) (2)	-	+35	1	dBm			
Thermal Resistance	-	-	33	°C/W			
Current Consumption <sup>(3)(4)</sup>	120 -	150 3	170 -	mA	V <sub>LC</sub> = +5 V V <sub>LC</sub> = 0 V		

### Notes:

- (1) 132 channels, +25 dBmV per channel (measured at the output), 6 MHz channel spacing
- (2) Two tones: 397 MHz and 403 MHz, +4 dBm per tone
- (3) Characterized with IADJ pin floating.
- (4) Adding a shunt resistor from the  $I_{ADJ}$  pin to ground will lower current but with some decrease in performance.

**Table 5: Shutdown Logic Control State Table** 

STATUS	VLC	AMPLIFIER	AMPLIFIER BIAS CURRENT					
Power up	+5 V	ON	150 mA					
Shutdown	0 V	OFF	3 mA					

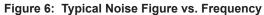


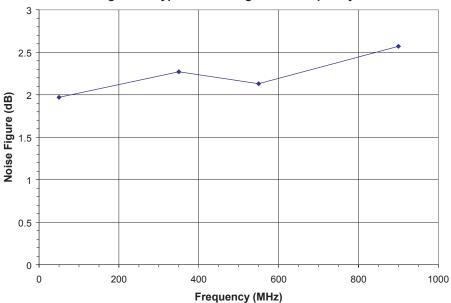
5 0 -5 -10 Return Loss (dB) -15 -20 -25 -30 ♦ S11 -35 ♦ S22 -40 0 100 200 300 400 500 600 700 900 1000 800 Frequency (MHz)

Figure 4: Typical Input and Output Return Loss (S11 and S22) vs. Frequency

0 -5 -10 -15 Isolation (dB) -20 -25 -30 -35 -40 -45 -50 400 0 100 200 300 500 600 700 800 900 1000 Frequency (MHz)

Figure 5: Typical Isolation (S12) vs. Frequency





# **APPLICATION INFORMATION**

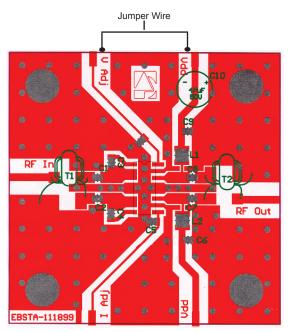


Figure 7: Evaluation Board Layout

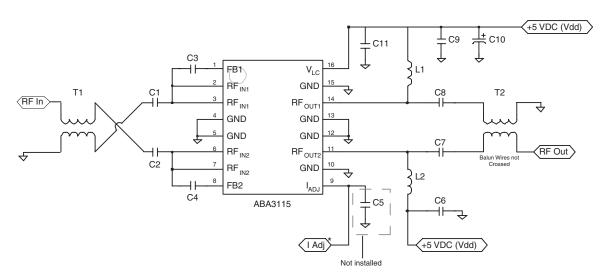


Figure 8: Evaluation Board Schematic

Note:

<sup>\*</sup>Connecting a resistor from IADJ to ground lowers current; Normal operation is with IADJ floating.

**Table 6: Evaluation Board Parts List** 

ITEM	DESCRIPTION	QTY	VENDOR	VENDOR PART NUMBER
C1-C4, C6, C9, C11	0.01uF CHIP CAP.	7	MURATA	GRM39X7R1103K25V
C7, C8	470 pF CHIP CAP.	2	MURATA	GRM39COG471J25V
C10	47 uF ELEC. CAP.	1	DIGI-KEY CORP	P5275-ND
C5	(not installed)			
L1, L2	390 nH CHIP INDUCTOR	2	COILCRAFT	1008CS-391XKBC
CONNECTORS (1)	75 $\Omega$ N MALE PANEL MOUNT	2	PASTERNACK ENTERPRISES	PE4504
T1, T2 <sup>(2)</sup>	Ferrite Core	2	FAIR-RITE	2843002702
(BALUN)	Wire		MWS WIRE IND.	T-2361429-20
	PCB	1	STAND. PRINTED CIRCUITS INC.	EBSTA-111899

### Notes:

- "N" Connector center pin should be approximately 80 mils in length.
  Connector tabs must be reduced by 150 mils.

NOTES:

1. MATERIAL:

3. Device must be soldered on PC board.

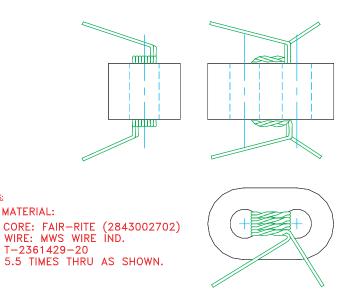
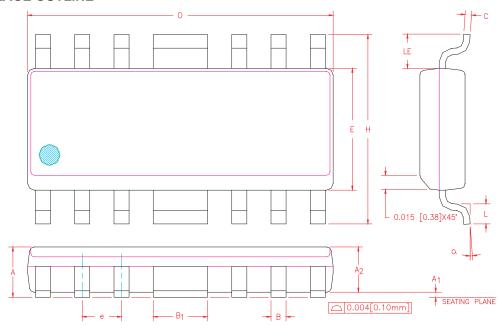


Figure 9:Balun Drawing

# **PACKAGE OUTLINE**



SYMBOL	INCHES		MILLIM	NOTE	
~oL	MIN.	MAX.	MIN.	MAX.	
Α	0.058	0.068	1.47	1.73	
A1	0.004	0.010	0.10	0.25	
A <sub>2</sub>	0.054	0.065	1.37	1.65	
В	0.013	0.020	0.33	0.50	
B <sub>1</sub>	0.062	0.070	1.58	1.78	
С	0.008	0.010	0.20	0.25	4
D	0.380	0.400	9.66	10.16	2
Е	0.150	0.160	3.81	4.06	3
е	0.050	BSC	1.27	BSC	
Н	0.226	0.244	5.74	6.20	
L	0.016	0.040	0.41	1.02	
LE	0.030	_	0.76	_	
a	0°	8*	0.	8*	

### NOTES:

- 1. CONTROLLING DIMENSION: INCHES
- 2. DIMENSION "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.006 [0.15mm] PER SIDE.
- 3. DIMENSION "E" DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED 0.010 [0.25mm] PER SIDE.
- 4. MAXIMUM LEAD TWIST/SKEW TO BE  $\pm 0.005$  [0.13mm].
- 5. LEAD THICKNESS AFTER PLATING TO BE 0.013 [0.33mm]  $_{\mbox{\scriptsize MAXIMUM}}$

0-006

Figure 9: S3 Package Outline - Modified 16 Pin SOIC

# **ABA3115**

**NOTES** 

#### **ABA3115**

### ORDERING INFORMATION

ORDER NUMBER	TEMPERATURE RANGE	PACKAGE DESCRIPTION	COMPONENT PACKAGING
ABA3115RS3P1	-40 to +85 °C	RoHS-Compliant Modified 16 Pin SOIC	3,500 piece Tape and Reel
ABA3115RS3P0	-40 to +85 °C	RoHS-Compliant Modified 16 Pin SOIC	Plastic tubes (50 pieces per tube)



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